

MITSUBISHI HVIGBT MODULES
CM800DZ-34H

3rd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE
 INSULATED TYPE

CM800DZ-34H



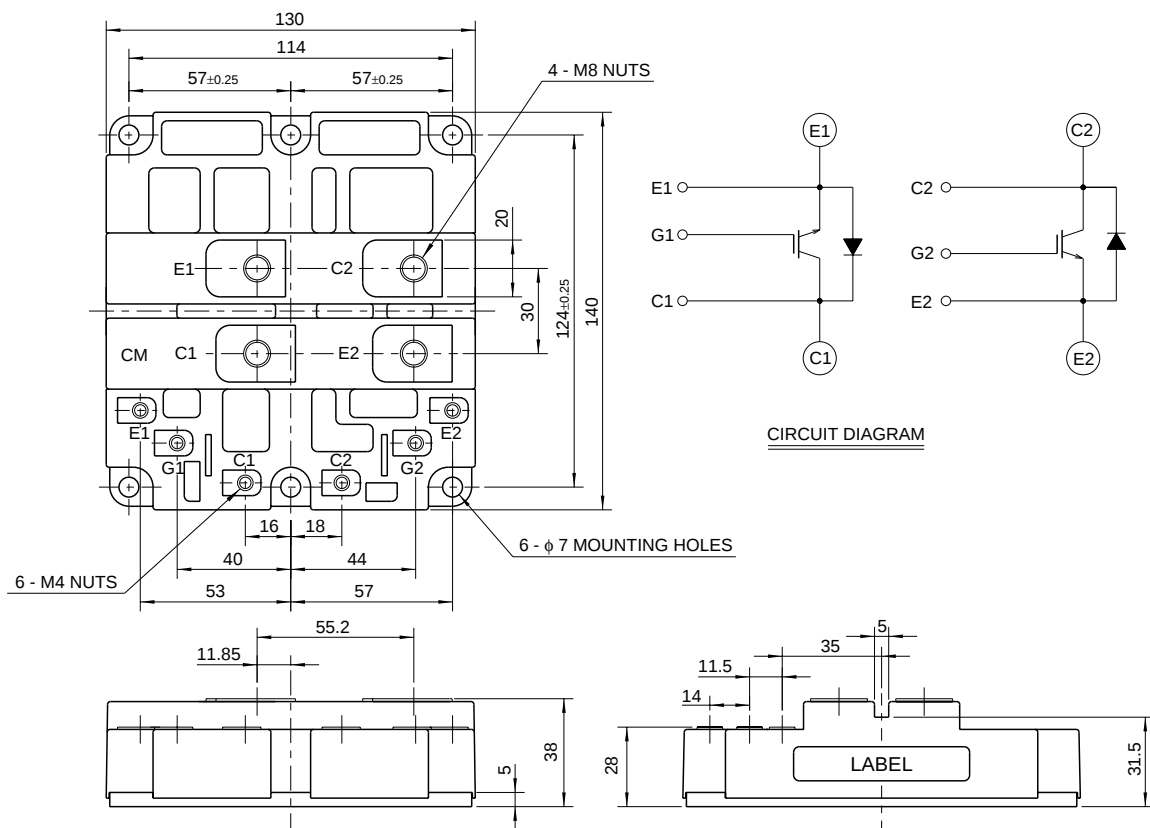
- IC800A
- VCES 1700V
- Insulated Type
- 2-elements in a pack

APPLICATION

Inverters, Converters, DC choppers, Induction heating, DC to DC converters.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



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Oct. 2002

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MAXIMUM RATINGS (T_j = 25°C)

Symbol	Item	Conditions	Ratings	Unit
V _{CES}	Collector-emitter voltage	V _{GE} = 0V	1700	V
V _{GES}	Gate-emitter voltage	V _{CE} = 0V	±20	V
I _C	Collector current	T _C = 25°C	800	A
I _{CM}		Pulse (Note 1)	1600	A
I _E (Note 2)		T _C = 25°C	800	A
I _{EM} (Note 2)	Emitter current	Pulse (Note 1)	1600	A
P _C (Note 3)		T _C = 25°C, IGBT part	5000	W
T _j	Junction temperature	—	−40 ~ +150	°C
T _{stg}	Storage temperature	—	−40 ~ +125	°C
V _{iso}	Isolation voltage	Charged part to base plate, rms, sinusoidal, AC 60Hz 1min.	4000	V
—	Mounting torque	Main terminals screw M8	6.67 ~ 13.00	N·m
		Mounting screw M6	2.84 ~ 6.00	N·m
		Auxiliary terminals screw M4	0.88 ~ 2.00	N·m
—	Mass	Typical value	1.0	kg

ELECTRICAL CHARACTERISTICS (T_j = 25°C)

Symbol	Item	Conditions	Limits			Unit
			Min	Typ	Max	
I _{CES}	Collector cutoff current	V _{CE} = V _{CES} , V _{GE} = 0V	—	—	12	mA
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 80mA, V _{CE} = 10V	4.5	5.5	6.5	V
I _{GES}	Gate-leakage current	V _{GE} = V _{GES} , V _{CE} = 0V	—	—	0.5	μA
V _{CE(sat)}	Collector-emitter saturation voltage	T _j = 25°C	—	2.80	3.64	V
		T _j = 125°C	—	3.20	—	
C _{ies}	Input capacitance	V _{CE} = 10V V _{GE} = 0V	—	72	—	nF
C _{oes}	Output capacitance		—	9.0	—	nF
C _{res}	Reverse transfer capacitance		—	3.6	—	nF
Q _G	Total gate charge	V _{CC} = 850V, I _C = 800A, V _{GE} = 15V	—	6.6	—	μC
t _d (on)	Turn-on delay time	V _{CC} = 850V, I _C = 800A	—	—	1.60	μs
t _r	Turn-on rise time	V _{GE1} = V _{GE2} = 15V	—	—	2.00	μs
t _d (off)	Turn-off delay time	R _G = 3.3Ω	—	—	2.70	μs
t _f	Turn-off fall time	Resistive load switching operation	—	—	0.80	μs
V _{EC} (Note 2)	Emitter-collector voltage	I _E = 800A, V _{GE} = 0V	—	2.60	3.38	V
t _{rr} (Note 2)	Reverse recovery time	I _E = 800A	—	—	2.70	μs
Q _{rr} (Note 2)	Reverse recovery charge	die / dt = −1600A / μs	—	150	—	μC
R _{th(j-c)Q}	Thermal resistance	Junction to case, IGBT part (Per 1/2 module)	—	—	0.025	K/W
R _{th(j-c)R}		Junction to case, FWDi part (Per 1/2 module)	—	—	0.043	K/W
R _{th(c-f)}	Contact thermal resistance	Case to fin, conductive grease applied (Per 1/2 module)	—	0.020	—	K/W

Note 1. Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.2. I_E, V_{EC}, t_{rr}, Q_{rr} & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.3. Junction temperature (T_j) should not increase beyond 150°C.

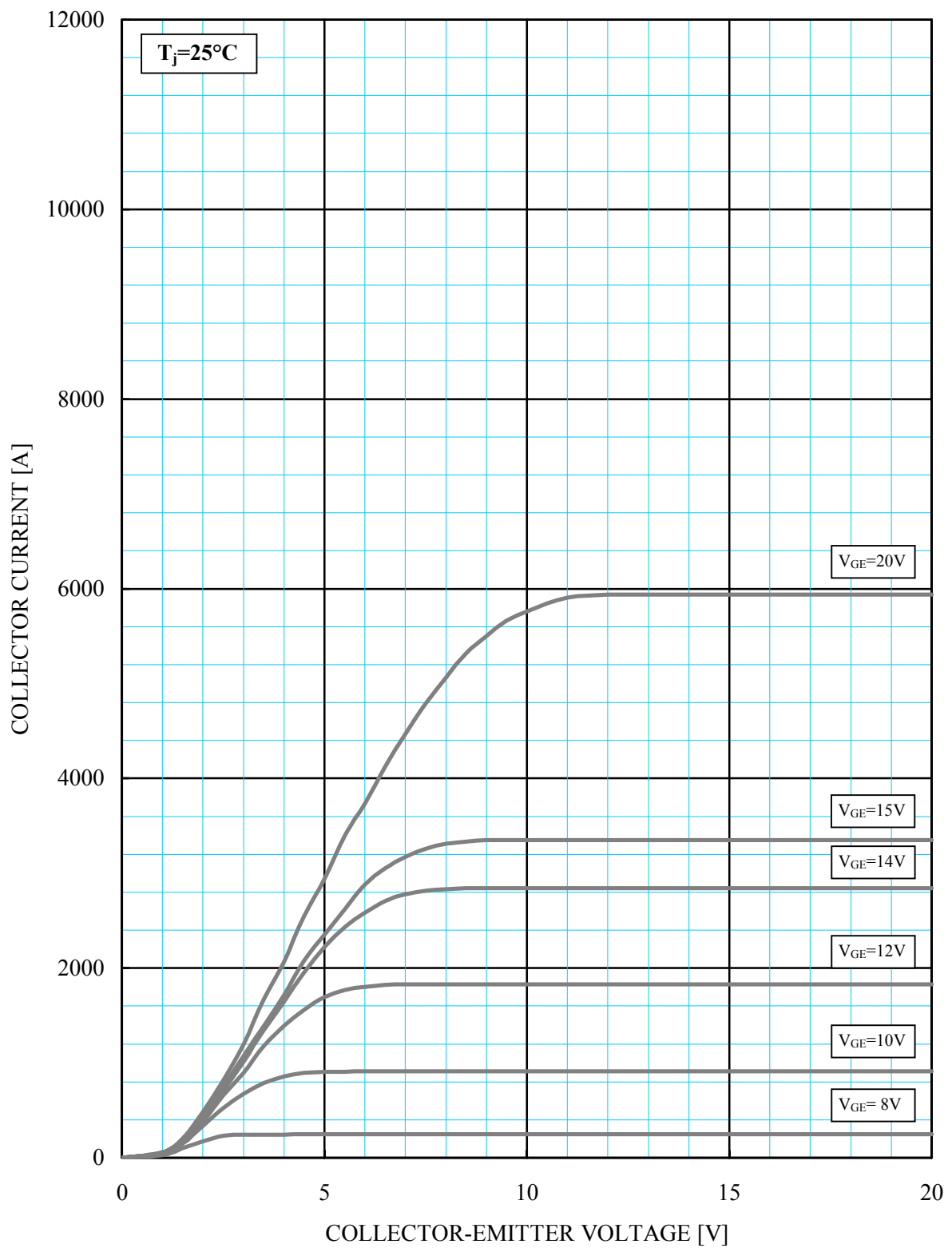
4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

SECURITY CODE		MITSUBISHI ELECTRIC CORPORATION							
SPEC.NAME Application Note	Prepared by	S.Iura	R E V	A	S.Iura				
	Checked by	M.Yamamoto			I.Umesaki				
	Approved by	M.Yamamoto			M.Tabata				
	DATE	Apr.8.2002			Aug.2.2002				

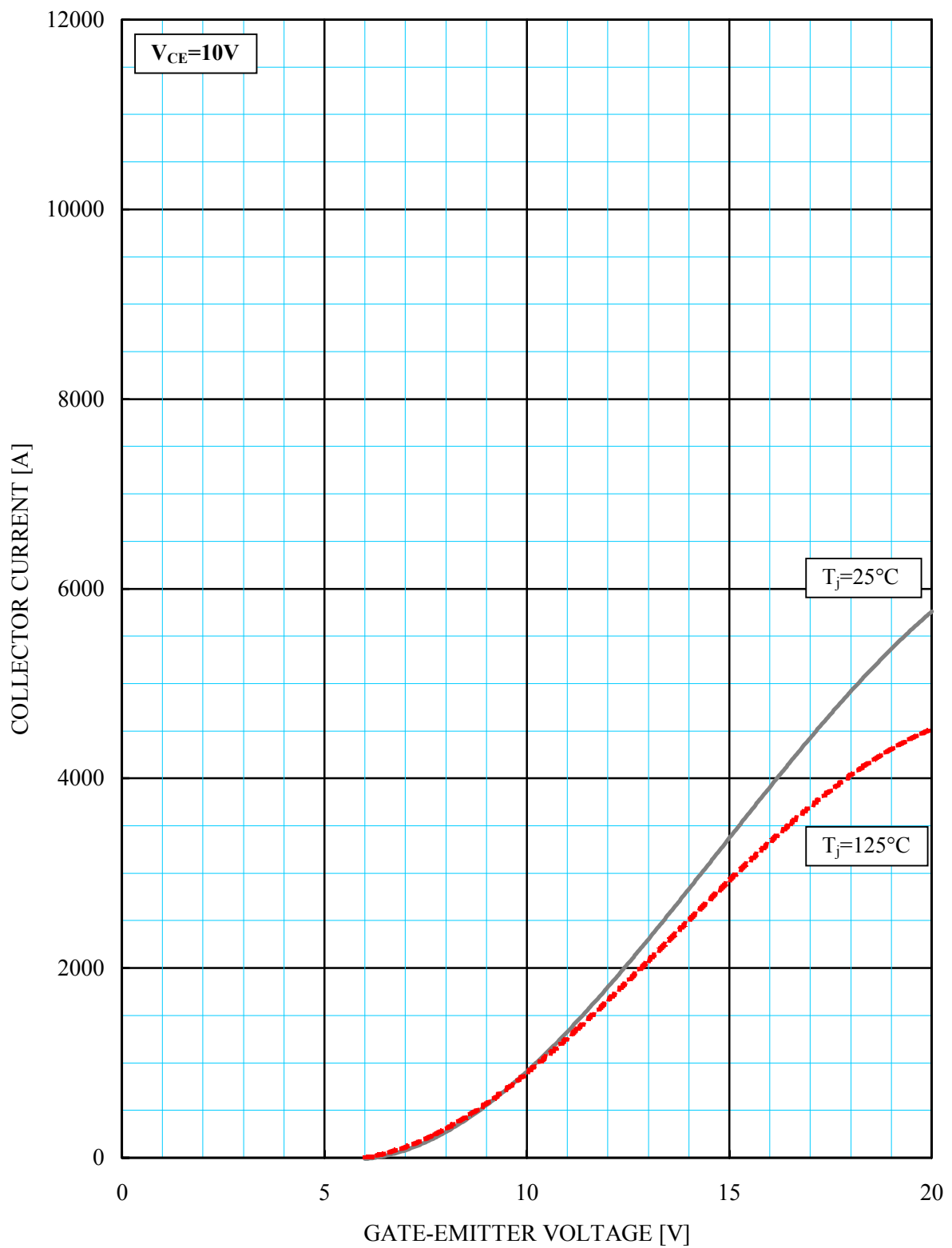
Data Sheet (CM800DZ-34H)

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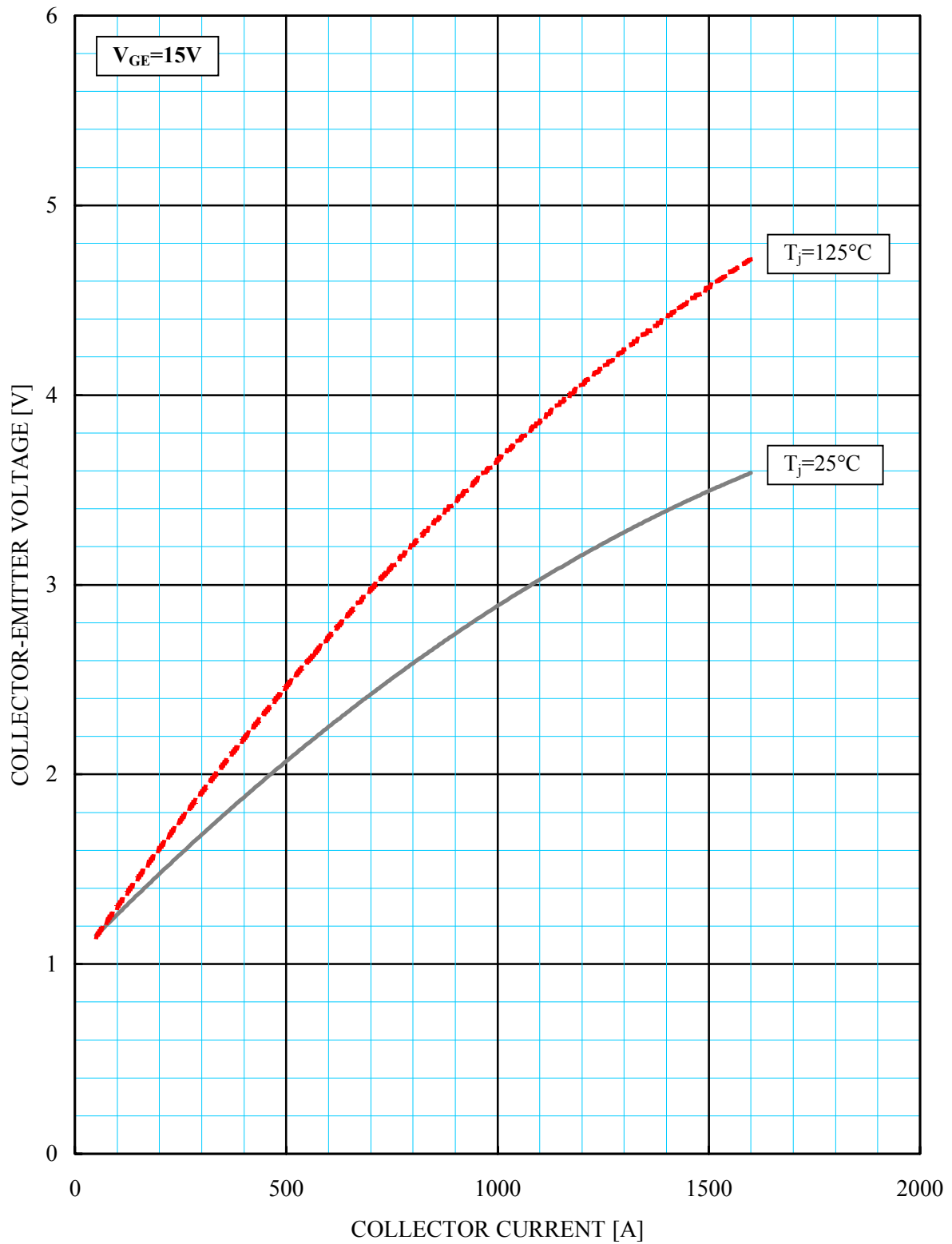
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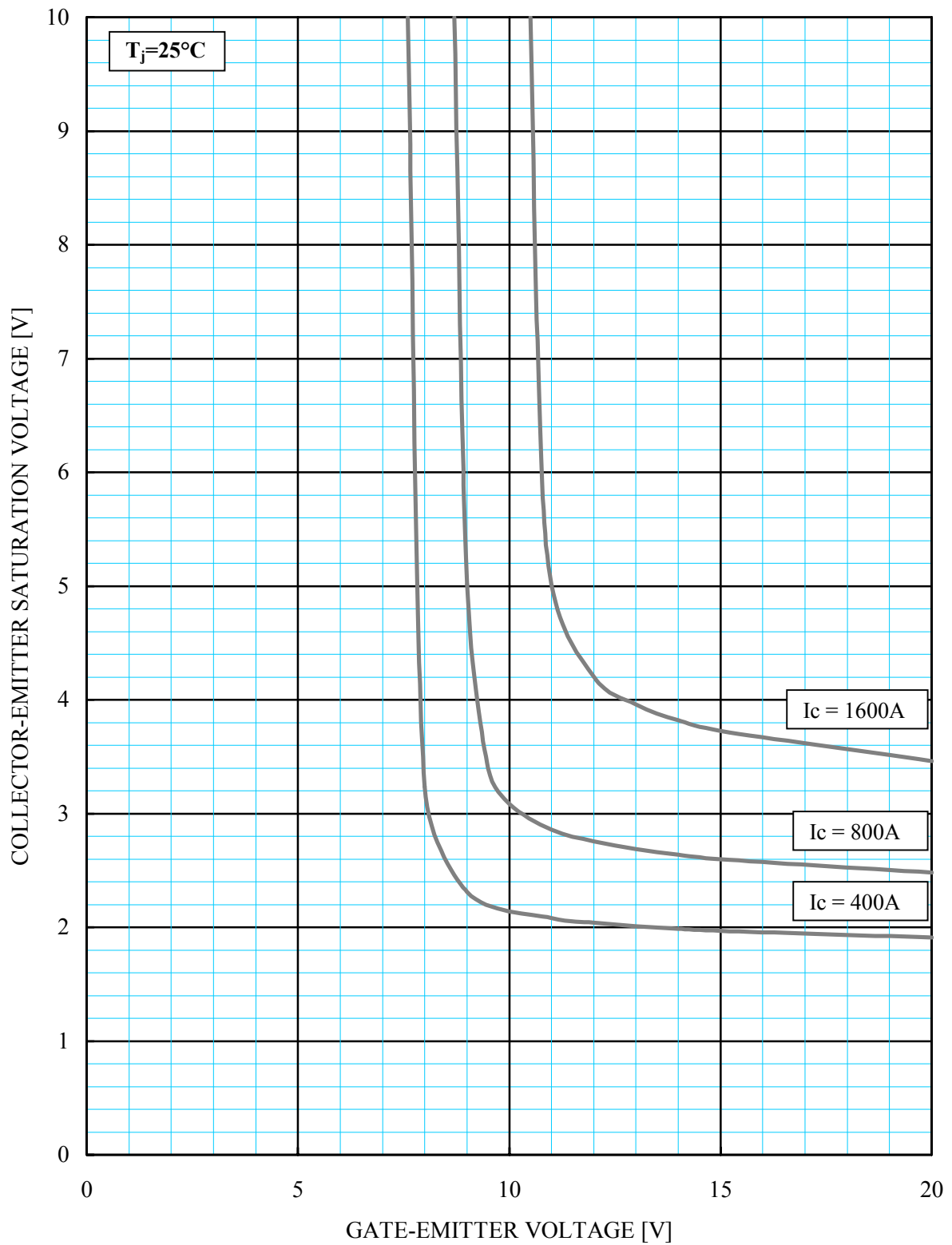
Output characteristics (typical)



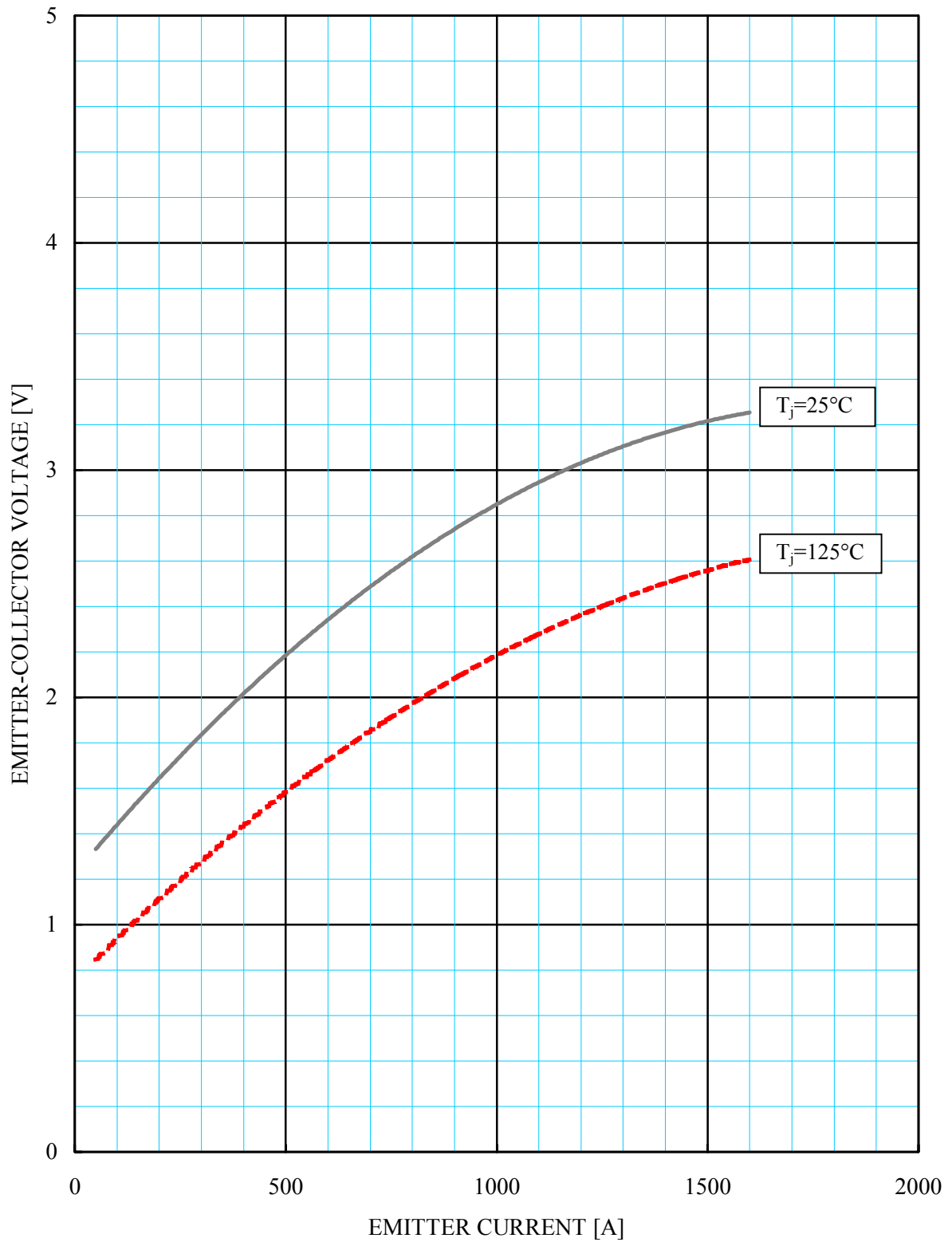
Transfer characteristics (typical)



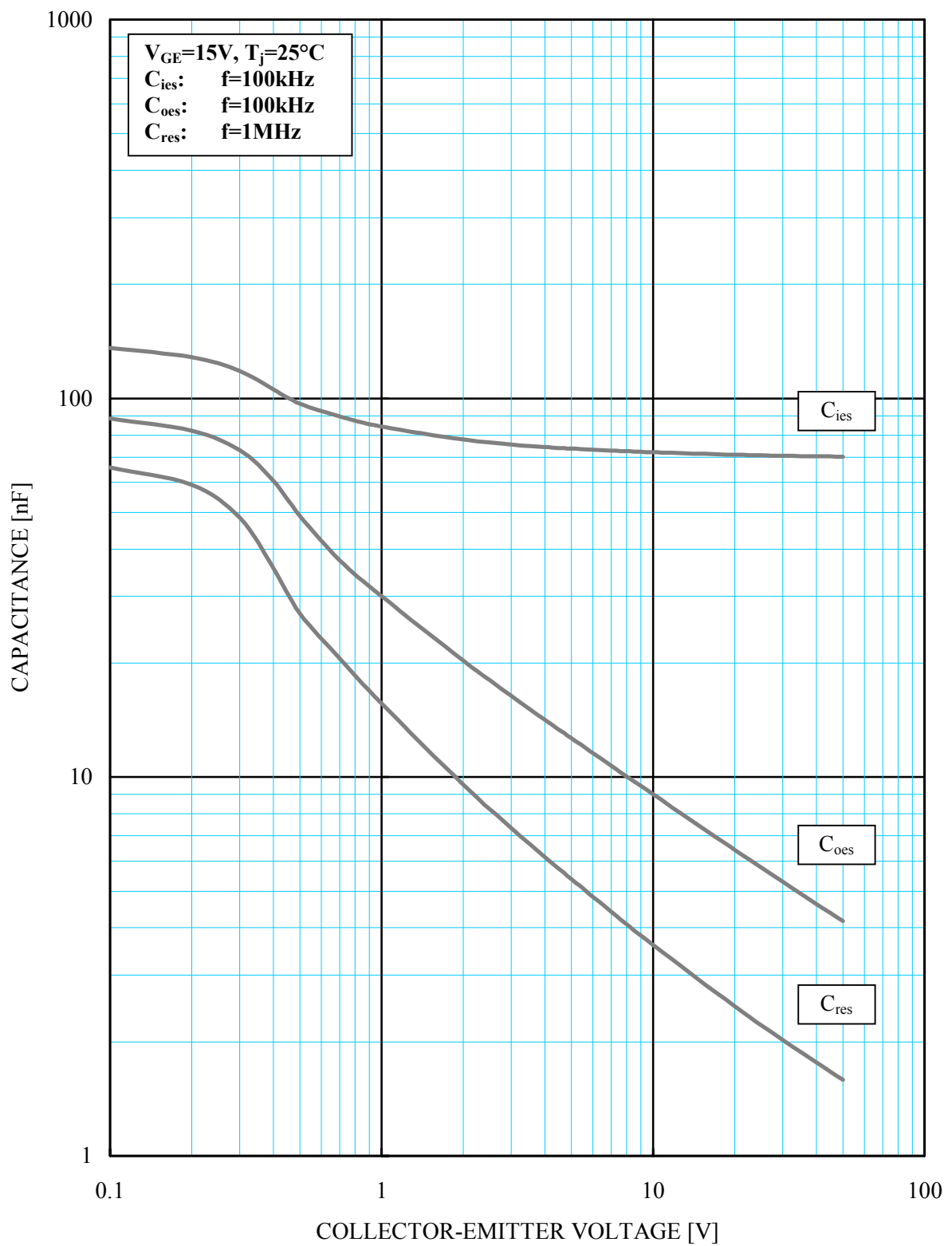
Collector-emitter saturation voltage characteristics (typical)



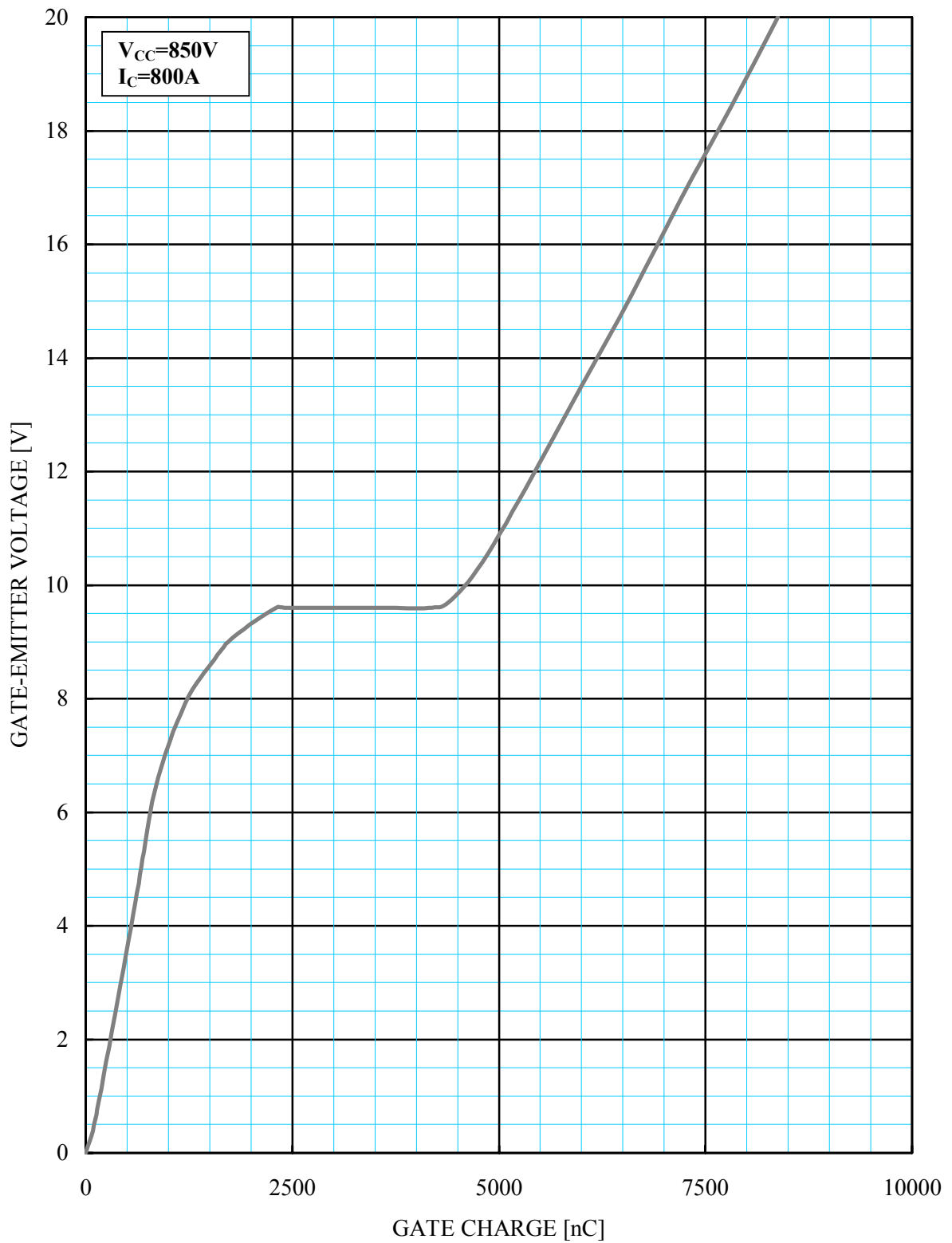
Collector-emitter saturation voltage characteristics (typical)



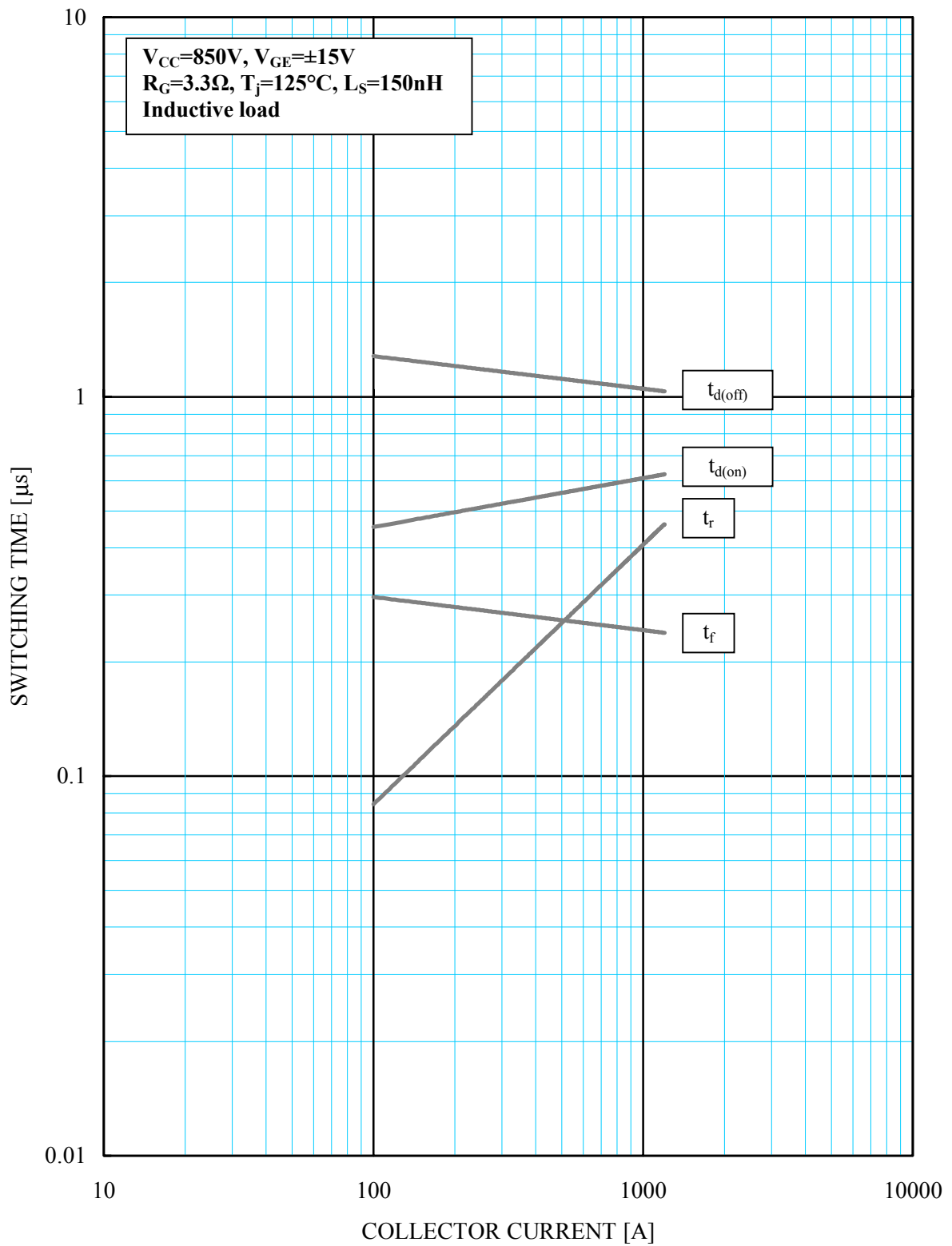
Free wheel diode forward voltage characteristics (typical)



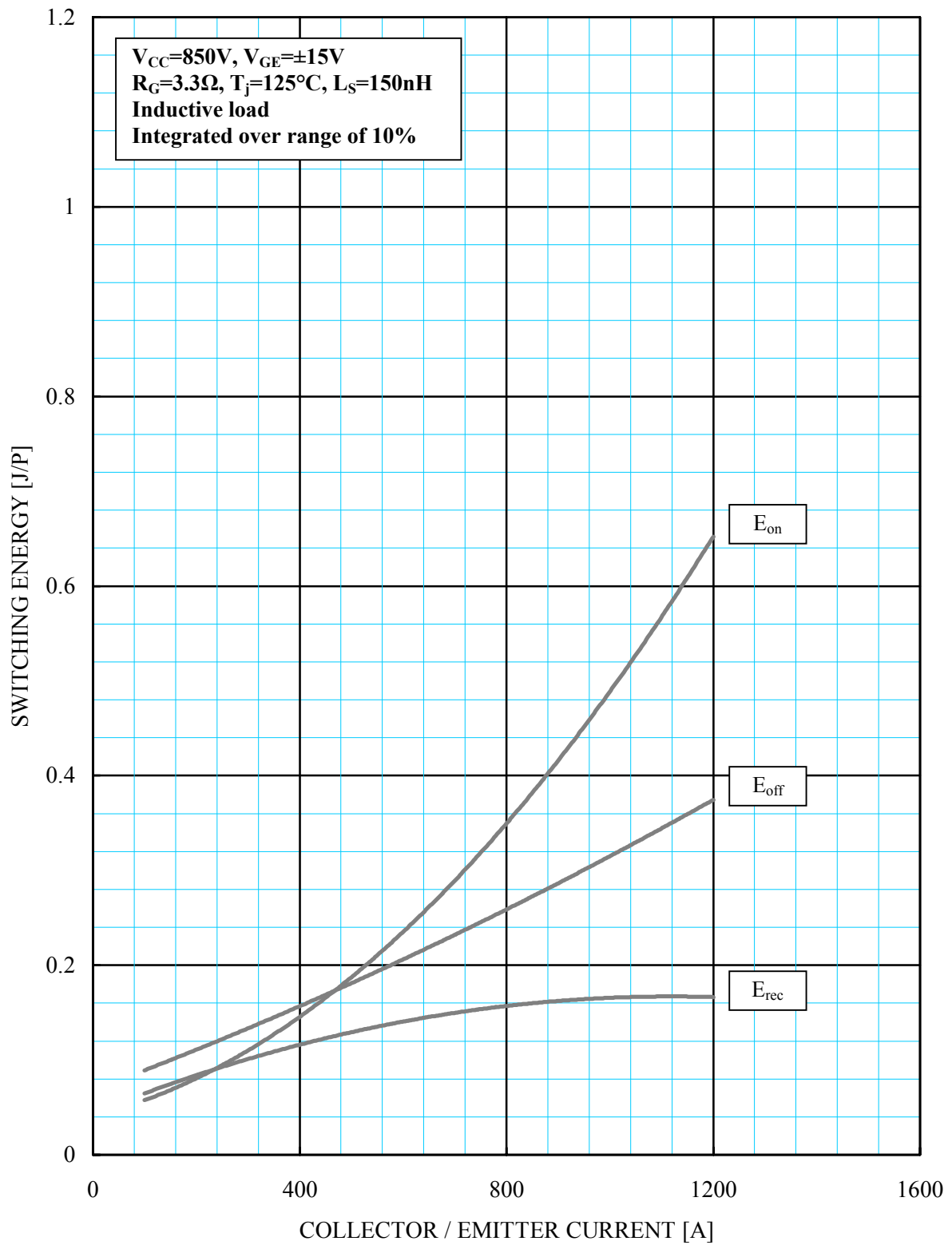
Capacitance characteristics (typical)



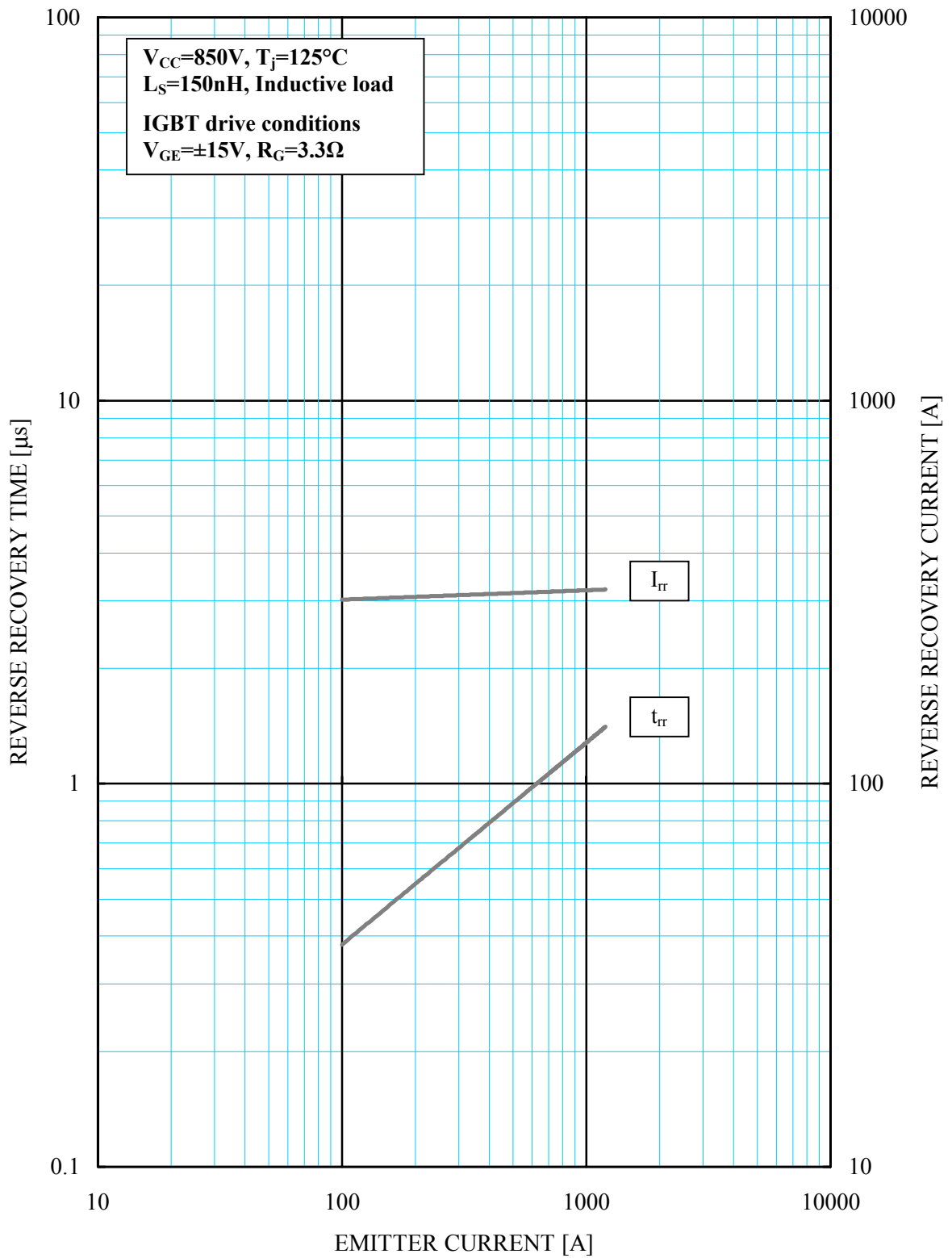
Gate charge characteristics (typical)



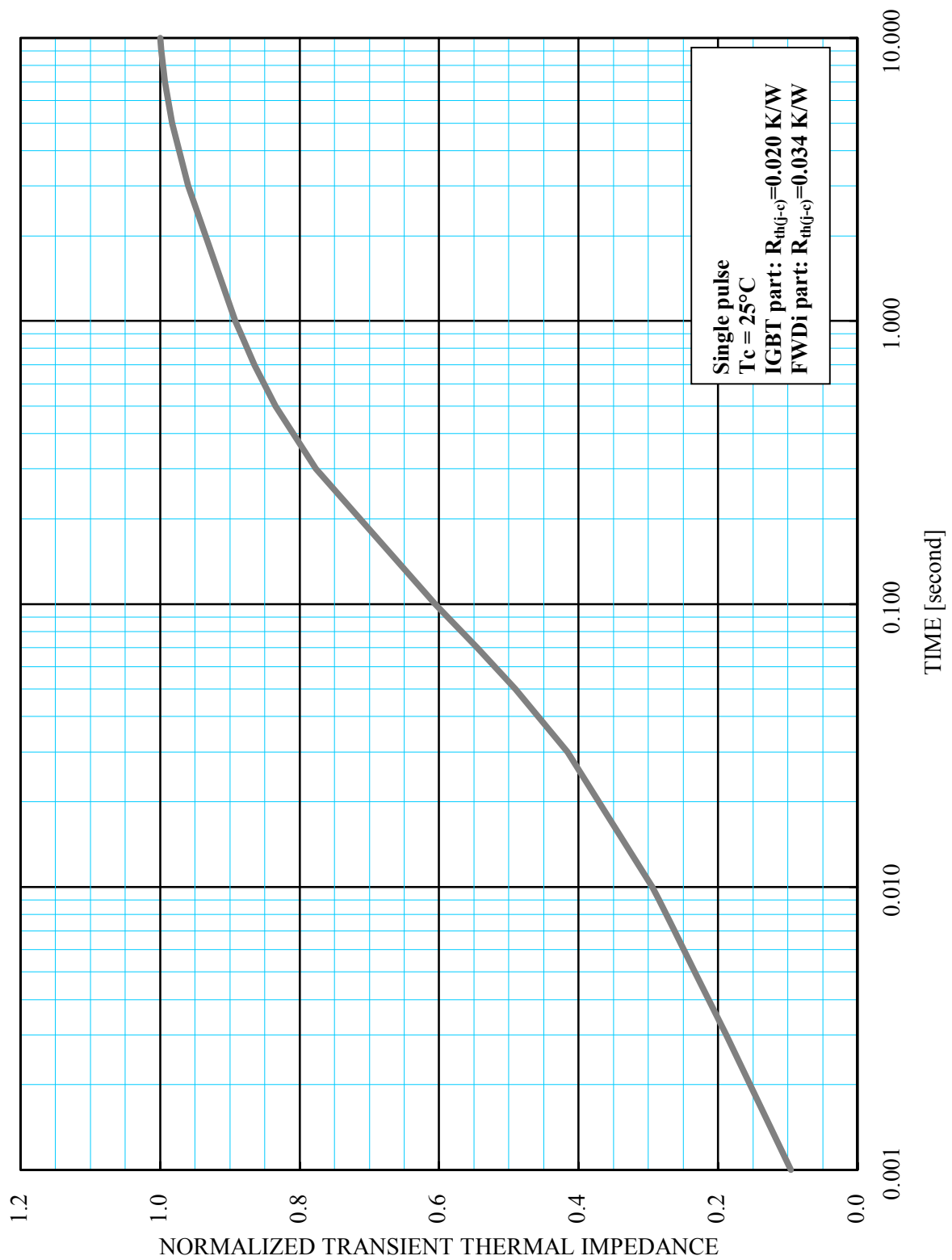
Half-bridge switching time characteristics (typical)



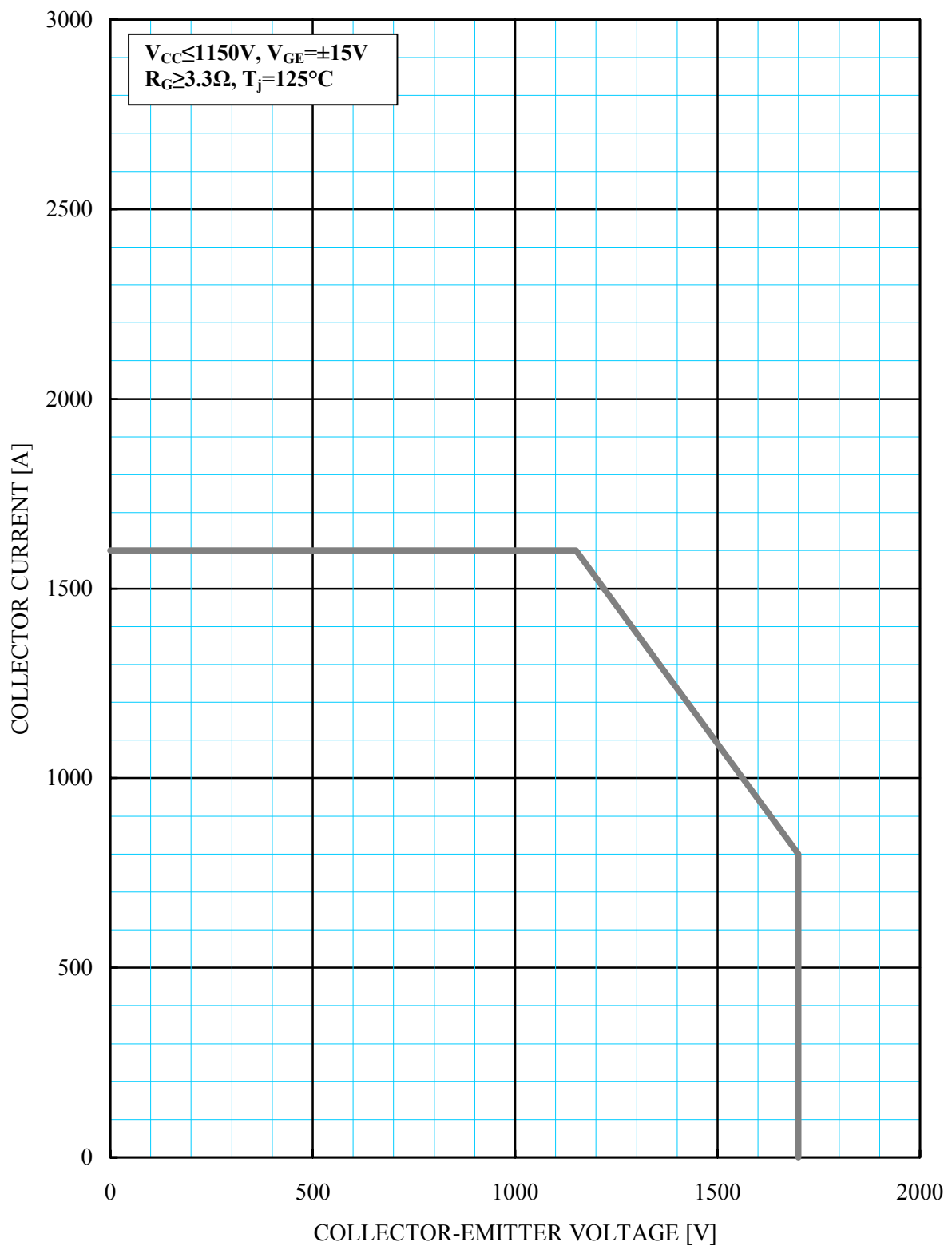
Half-bridge switching energy characteristics (typical)



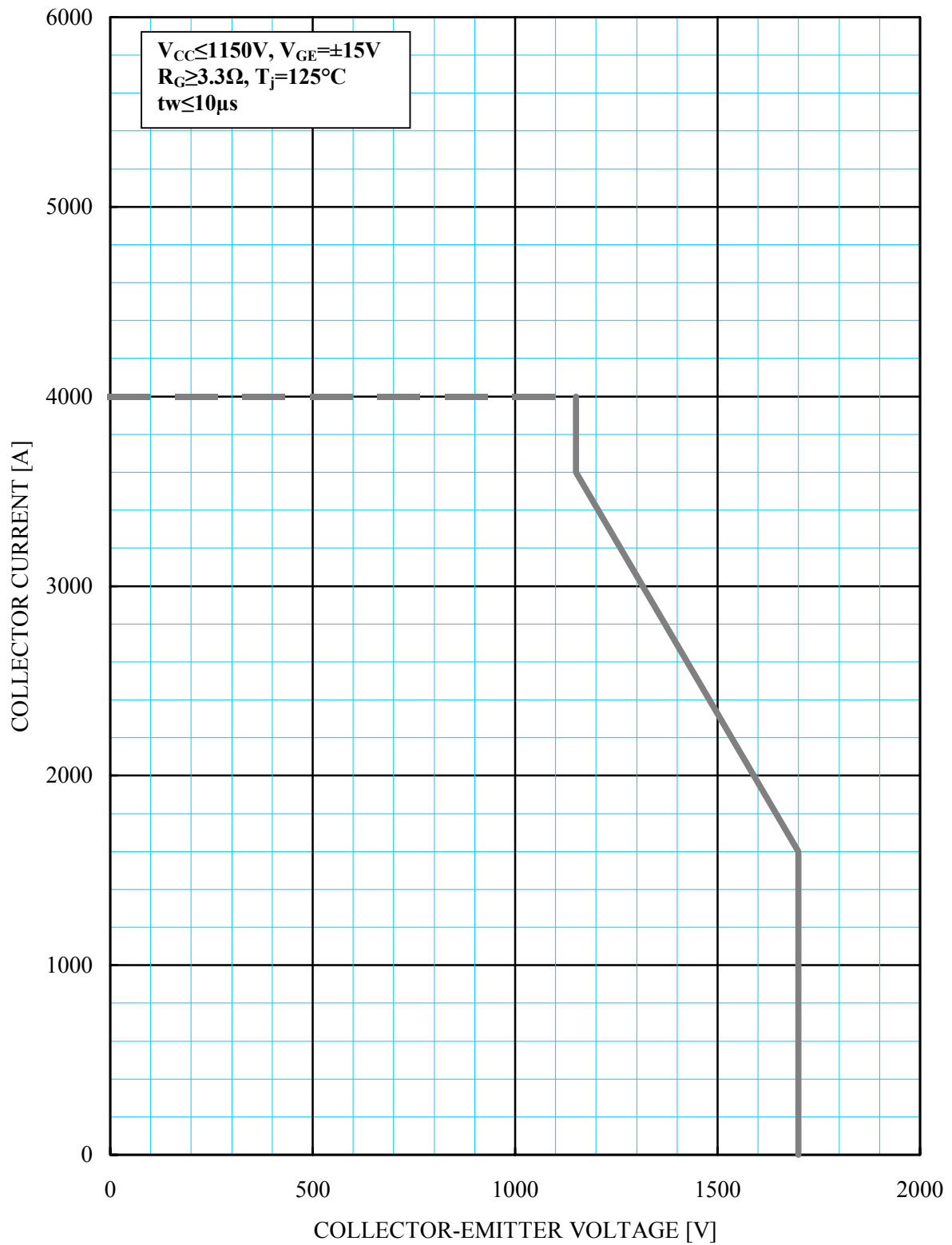
Reverse recovery characteristics (typical)



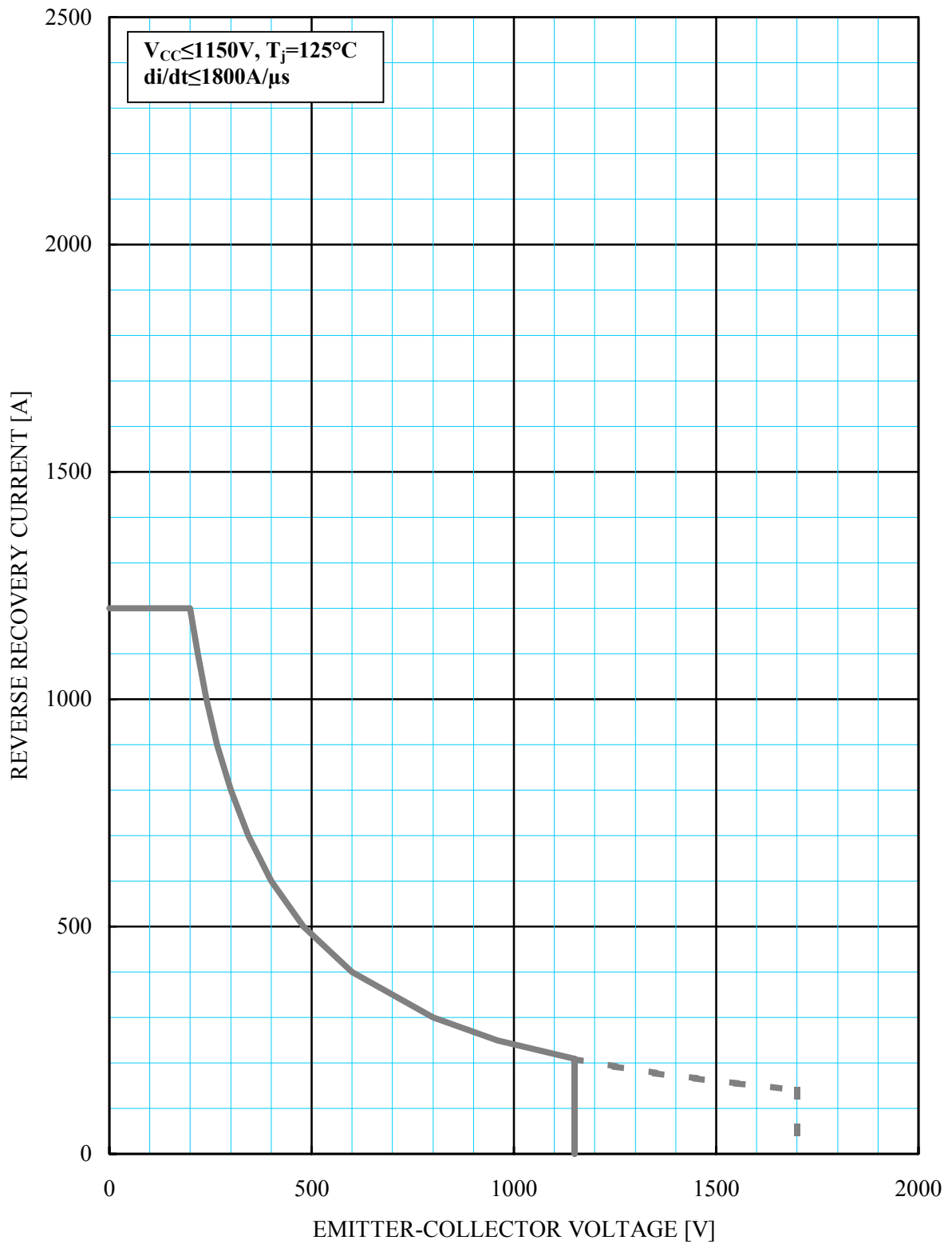
Transient thermal impedance characteristics



Turn-off switching safe operating area (SWSOA / RBSOA)



Short circuit safe operating area (SCSOA)



Reverse recovery safe operating area (RRSOA / Di-SOA)